

Component-based Software Development Framework for Embedded IoT Devices (仮)

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Received: March 4, 2014, Accepted: August 1, 2014

Abstract:

Keywords:

1. Introduction

The Internet of Things (IoT) is an essential next evolutionary step for the Internet [1] in which various items and platforms, for example, wearable devices and smart devices, will be connected via the Internet to further enrich people's lives. The IoT uses embedded systems such as data sensors and controlling actuators as elemental constituents, and they must demonstrate high quality and high performance. This requirement has led to an increase in their complexity and scale; moreover, these systems need to have low production costs and short development cycles.

Complex and large-scale software systems can be developed efficiently by using component-based techniques [2], [3]. Component-Based Development (CBD) is a design technique that can be applied to reusable software development. Verification of component-based systems has been extensively researched [4], [5]. Individual component diagrams enable the visualization of an entire system. In addition, component-based systems are flexible with regard to extensibility and specification changes. The TOPPERS embedded component system (TECS) [6], AUTOSAR [7], and SaveCCM [8] are typical CBD tools for embedded systems.

In addition, scripting languages, such as Ruby, JavaScript, Perl, Python, and Lua, offer efficient approaches to software development. Currently, most embedded software are programmed in C language. However, development in C language results in large code size, incurs high costs, and requires significant development time. In contrast, the use of scripting languages improves the efficiency of software engineering and can shorten the development period because it is relatively easy to reuse scripts.

For embedded systems, real-time properties, such as estimation of worst-case execution time, are very important. Although scripting languages are easy to use and read, their execution requires more time than that required by the codes written in C. Therefore, applying scripting languages to embedded systems is

difficult. To address the above limitation, “mruby on TECS,” a component-based framework for running script programs, has been proposed [9]. This framework integrates two technologies, i.e., mruby, which is a lightweight implementation of Ruby for embedded systems [10], [11], and TECS, which is a component-based framework for embedded systems [6], [12].

This paper proposes an extended framework of mruby on TECS that can be applied to embedded network software development for IoT devices. In the proposed framework, a component-based TCP/IP protocol stack, TINET+TECS [13], is comprised, and it is possible to utilize TINET function from mruby programs.

TINET is a compact TCP/IP protocol stack for embedded systems [14]. TINET comprises many complex source codes, i.e., it contains many files and defines many macros, which can be problematic for software developers seeking to maintain, extend, and analyze the software. TINET+TECS is a componentized TIENT with TECS to improve the configurability and scalability of TCP/IP software.

In addition, this paper proposes a component-based dynamic memory allocator, TLSF+TECS. TLSF is a dynamic memory allocator for real-time systems, which can always run with $O(1)$ and improve memory usage efficiency by deviding memory blocks in two stages. In the current version of TLSF, memory contention may occur when multiple threads run at the same time. TLSF+TECS is a componentized TLSF memory allocator, which can be thread-safe allocator because each component has its own heap area.

Contributions: The proposed framework provides the following contributions.

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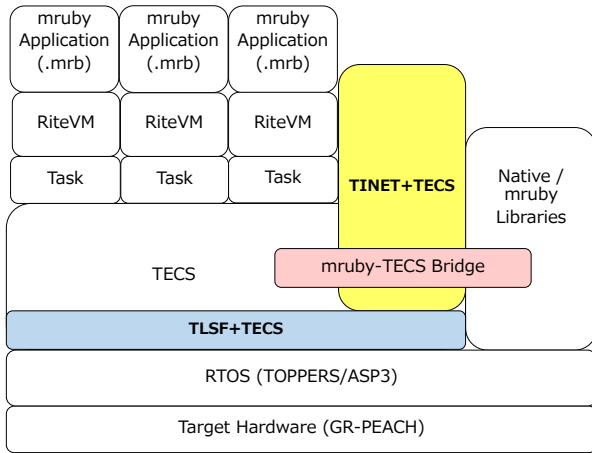


Fig. 1 System model of the proposed framework

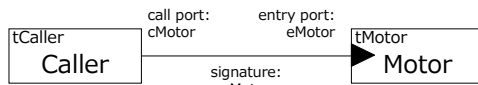


Fig. 2 Component Diagram

Organization: The remainder of this paper is organized as follows. Section 2 introduces the system model of the proposed framework and the basic technologies, i.e., TECS, mruby, and mruby on TECS. Section 3 describes the design and implementation of the proposed framework, including TINET+TECS and TLSF+TECS. Section 4 evaluates the proposed framework. Related work is discussed in Section 5. Conclusions and suggestions for future work are presented in Section 6.

2. System Model

This section describes the system model of the proposed framework, including basic technologies such as TECS. The system model of the proposed framework is shown in Fig.1.

The proposed framework is an extension of mruby on TECS framework [9] [15], and utilizes two technologies: mruby and TECS. In this section, TECS, mruby, and mruby on TECS framework are described.

2.1 TECS

TECS is a component system suitable for embedded systems. TECS can increase productivity and reduce development costs due to improved reusability of software components. TECS also provides component diagrams, which help developers visualize the overall structure of a system.

In TECS, component deployment and composition are performed statically. Consequently, connecting components does not incur significant overhead and memory requirements can be reduced. TECS can be implemented in C, and demonstrates various feature such as source level portability and fine-grained components.

2.1.1 Component Model

Fig.2 shows a component diagram. A *cell*, which is an instance of a component in TECS, consists of *entry* ports, *call* ports, attributes and internal variables. An *entry* port is an interface that

```

1 signature sMotor {
2   int32_t getCounts( void );
3   ER resetCounts( void );
4   ER setPower( [in]int power );
5   ER stop( [in] bool_t brake );
6   ER rotate( [in] int degrees,
7             [in] uint32_t speed_abs,
8             [in] bool_t blocking );
9   void initializePort( [in]int32_t type );
10 };

```

Fig. 3 Signature Description

```

1 celltype tCaller {
2   call sMotor cMotor;
3 };
4 celltype tMotor {
5   entry sMotor eMotor;
6   attr {
7     int32_t port;
8   };
9   var {
10    int32_t currentSpeed = 0;
11  };
12 };

```

Fig. 4 Celltype Description

provides functions to other *cells*, and a *call* port is an interface that enables the use of other *cell*'s functions. A *cell* has one or more *entry* ports and *call* ports. *Cell* functions are implemented in C.

The type of *entry/call* port is defined by a *signature*, which is a set of functions. A *signature* is the interface definition of a *cell*. The *cell*'s *call* port can be connected to the *entry* port of another *cell* by the same *signature*. Here, *celltype* defines one or more *call/entry* ports, attributes, and internal variables of a *cell*.

2.1.2 Component Description

In TECS, components are described by *signature*, *celltype*, and build written in component description language (CDL). These components are described as follows.

Signature Description

The *signature* defines a *cell* interface. The *signature* name follows the keyword *signature* and takes the prefix “s” e.g., sMotor (Fig.3). In TECS, to clarify the function of an interface, specifiers such as [in] and [out] are used, which represent input and output, respectively.

Celltype Description

The *celltype* defines *entry* ports, *call* ports, attributes, and variables. A *celltype* name with the prefix “t” follows the keyword *celltype*, e.g., tCaller (Fig.4). To define *entry* ports, a *signature*, e.g., sMotor, and an *entry* port name, e.g., eMotor, follow the keyword *entry*. *Call* ports are defined similarly. Attributes and variables follow the keywords *attr* and *var*, respectively.

Build Description

The build description is used to instantiate and connect *cells*. Fig.5 shows an example of a build description. A *celltype* name and *cell* name, e.g., tMotor and Motor, respectively, follow the keyword *cell*. To compose *cells*, a *call* port, *cell*'s name, and an *entry* port are described in that order. In Fig.5, *entry* port eMotor in *cell* Motor is connected to *call* port cMotor in *cell* Caller. *C_EXP* calls macros defined in C files.

```

1 cell tMotor Motor {
2   port = C_EXP("PORT_A");
3 };
4 cell tCaller Caller {
5   cMotor = Motor.eMotor;
6 };

```

Fig. 5 Build Description

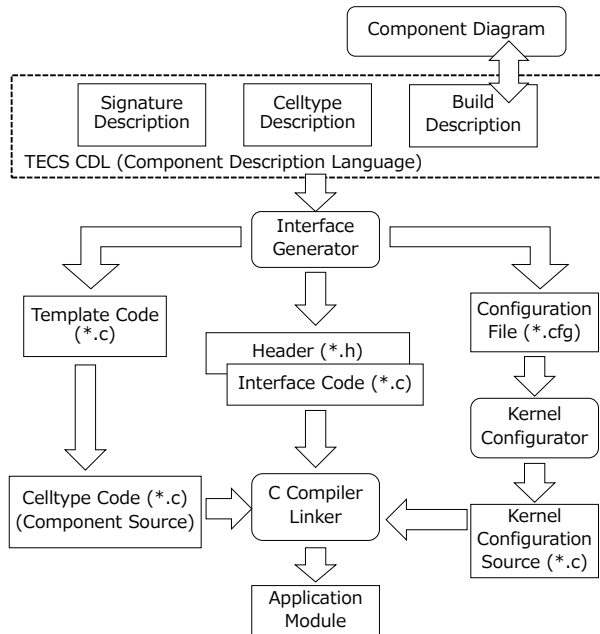


Fig. 6 Development flow using TECS

2.1.3 Development Flow

Fig.6 shows the development flow using TECS. TECS generator generates the interface code (.H and .C) and the configure file of the RTOS (.cfg) from the CDL file.

Software developers using TECS can be divided into component designers and application developers. Component designers define signatures, which are interfaces between cells, and celltypes, which are types of cells. Using the template code generated from the CDL file in which these are defined, component designers implement the functions and behaviors of the component in C language. The source code implementing the function of the component is called a celltype code. Application developers develop applications by using component diagrams and predefined celltype to connect cells with build description. An application module is generated by compiling and linking the header, the interface code, and the celltype code.

2.2 mruby

mruby is a light-weight implementation of the Ruby programming language complying to part of the ISO standard. Ruby is an object-oriented scripting language [16] with classes and methods, exceptions, and garbage collection functions. It is easy to use and read due to its simple grammar and Ruby requires fewer lines of code than C. Ruby improves the productivity of software development due to its simple grammar and object-oriented functions.

mruby, which retains the usability and readability of Ruby, requires fewer resources, and thus, is suitable for embedded systems. In addition, mruby includes a VM mechanism, and thus,

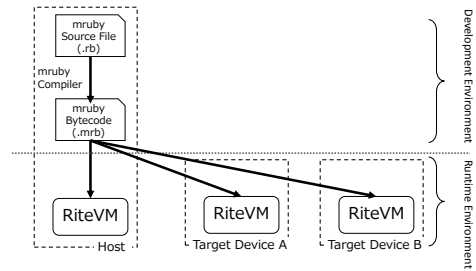


Fig. 7 mruby/RiteVM mechanism

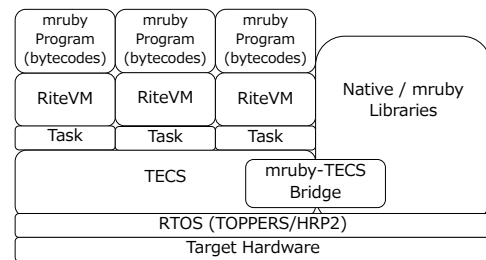


Fig. 8 System model of existing mruby on TECS

mruby programs can run on any operating system as long as a VM is implemented. The mruby/RiteVM mechanism is shown in Fig.7. The mruby compiler translates an mruby code into a bytecode, which can be interpreted by a RiteVM; thus, mruby programs can be executed on any target device with a RiteVM.

2.3 mruby on TECS

mruby on TECS is a component-based framework for running an mruby script language on embedded systems. This framework integrates two technologies, mruby and TECS, and enables to develop embedded software using a script language without slowing down the execution time.

2.3.1 System Model of mruby on TECS

The present mruby on TECS system model is shown in Fig.8. Each mruby program, which is a bytecode, runs on its own RiteVM as a componentized task of an RTOS. TECS components support various embedded drivers such as motor and sensor drivers.

An mruby-TECS bridge provides native libraries for mruby and can call a native program (e.g., C legacy code) from an mruby program. The mruby-TECS bridge also provides TECS components for receiving the invocation from an mruby program.

In this paper, TOPPERS/ASP3 [17], [18] is the target RTOS and is based on μ ITRON [19]. However, mruby on TECS does not depend on the RTOS because TECS supports not only TOPPERS/HRP2 but also the other RTOSs such as OSEK [20] and TOPPERS/HRP2 [21], [22].

2.3.2 mruby-TECS Bridge

There is a significant difference between the execution times of mruby and C language codes. According to [9], mruby programs are several hundred times slower than C programs and the execution of an mruby bytecode on a RiteVM is not as efficient as that of C code. Thus, it is difficult to use mruby exclusively.

Using Ruby on embedded devices improves productivity and maintainability because it is easy to use and read. However, some

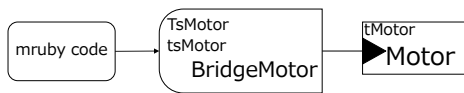


Fig. 9 mruby-TECS bridge

C language codes are required to manipulate actuators and sensors and ensure that critical sections of the code run quickly.

Fig.9 illustrates an mruby-TECS bridge used to control a motor. The left side of BridgeMotor belongs to the mruby program. The right side of BridgeMotor belongs to TECS component.

The mruby-TECS bridge generates a *celltype*, which is called from the mruby code, and an mruby class, which corresponds to a developer-specified TECS component to invoke a C function from the mruby program.

The generated mruby-TECS bridge supports registration of classes and methods for mruby. Methods in an mruby class are defined by generation codes for an mruby-TECS bridge, such as *setPower* and *stop*. Thus, when a method is called in an mruby program, the mruby-TECS bridge calls the function defined in the TECS component such as a *Motor cell*.

3. Proposed Framework

3.1 TINET+TECS

3.1.1 TINET

TINET is a compact TCP/IP protocol stack for embedded systems based on the ITRON^{*1} TCP/IP API Specification [23], developed by the TOPPERS Project [12]. TINET has been released as an open-source tool.

To satisfy restrictions for embedded systems in terms of, for example, memory capacity, size, and power consumption, TINET supports the following functions:

- minimum copy frequency,
- elimination of dynamic memory control,
- asynchronous interfacing,
- error detailing per API.

Overview: TINET runs as middleware on TOPPERS/ASP3 [24] [25], a real-time kernel based on μ ITRON [19]. As it is compatible with TOPPERS RTOS, TINET also supports other RTOSs such as TOPPERS/ASP and TOPPERS/JSP.

Fig.10 shows the hierarchy diagram of TINET and TOPPERS/ASP3. Users transmit and receive data using a Communication End Point (CEP), an interface that functions like a socket. In the transmission process, headers are attached to the data body passed to the CEP at each protocol layer before the data are transmitted from the network device. In the reception process, the headers of the data bodies received by the network device are analyzed at each protocol layer, and the data are then passed to the CEP.

A TCP reception point called the REP stands by to receive connection requests from the partner side. The REP has an IP address (*myaddr*) and a port number (*myportno*) as attributes and performs functions such *bind()* and *listen()*.

In TINET, the amount of data copying between each protocol

^{*1} ITRON is a real-time operating system (RTOS) developed by the TRON project.

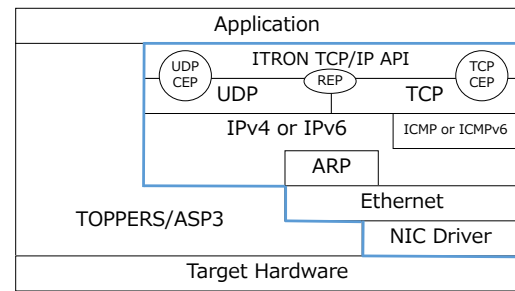


Fig. 10 TINET and TOPPERS/ASP3 hierarchy diagrams

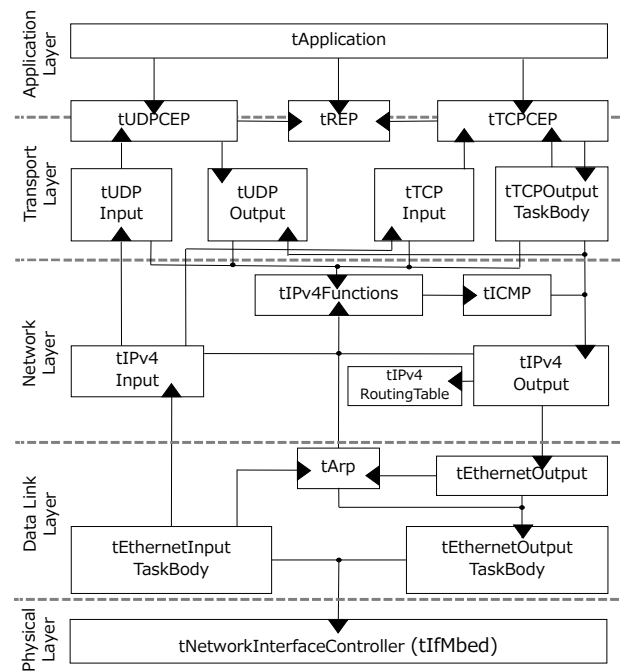


Fig. 11 Component diagram of a protocol stack

layers is minimized. In standard computing systems, the TCP/IP protocol stack has large overheads in terms of execution time and memory consumption because the data are copied at each protocol layer. To solve this problem, TINET does pass the pointer of the data buffer between each protocol layer instead of performing data copying.

3.1.2 Component Design of TINET+TECS

TINET+TECS, the proposed componentized TCP/IP protocol stack, comprises a number of some TECS components. This section describes the components of the TINET+TECS framework with the aid of component diagrams.

Components of a protocol stack

The components of a TINET+TECS protocol stack are shown in Fig.11. Note that some small particle components, such as a kernel object, data queues, and semaphores, are omitted to simplify the component diagram. In TINET+TECS, the components are divided for each protocol, and functionalities such as input and output functions are defined as respective components. By using such small grain components, software visibility is improved. The components of each protocol are described in the following.

Application layer: An application in TINET+TECS is implemented as a component such as *tApplication*. Software

with TINET uses ITRON TCP/IP API [23] such as *tcp_snd.dat* and *tcp_rcv.dat*. In TINET+TECS, the application component calls TECS functions such as *cTCPAPI_sendData* and *cTCPAPI_receiveData*. Moreover, in TINET+TECS supporting a TECS adapter, an existing application with TINET can run on the TINET+TECS framework without transporting, and therefore, software can be developed either using existing methods or as TECS components.

Transport layer: tTCPCEP (tUDPCEP) and tREP are, respectively, CEP and REP components TCP (UDP). For example, a server program supporting multiple clients can be developed by preparing multiple tTCPCEP components. tTCPInput (tUDPInput) and tTCPOutput (tUDPOutput) are components for performing, respectively, receiving and sending processing in the transport layer.

Network layer: The tIPv4Input and tIPv4Output components perform, respectively, the receiving and sending processing in the network layer. The tIPv4Functions component performs functions such as checksum, the tICMP component is used for the Internet Control Message Protocol (ICMP), and the tIPv4RoutingTable component operates a routing table.

Data link layer: tEthernetInputTaskBody and tEthernetOutputTaskBody (tEthernetOutput) are components for performing, respectively, receiving and sending processing in the data link layer. The tAtp component is for implementing the Address Resolution Protocol (ARP).

Physical layer: The tNetworkInterfaceContoroller component implements a network device driver. Software can be run on other devices by replacing the component because only the component depends on the target device.

To utilize the protocol stack in the same manner in the original TINET, communication object components such as tTCPCEP, tUDPCEP, and tREP are defined as an interface between TINET+TECS and an application. The communication object component corresponds to a CEP or REP of the original TINET. Application developers can utilize the TINET+TECS functionalities by generating and combining as many components as necessary.

The protocol stack of TINET+TECS supports the coexistence of multiple protocols. Though its use of IPv6 and Point-to-Point Protocol (PPP) components, TINET+TECS can make IPv4 and IPv6 coexist and support PPP without modification of component implementation.

Memory allocator component

The original TINET eliminates dynamic memory control to meet the severe memory restrictions of embedded systems. A memory area for sending/receiving data in the protocol stack is allocated and released within a predetermined area. The memory allocator component allows for elimination of dynamic memory control in TINET+TECS by providing a requested memory area from the statically allocated memory area.

The memory allocator component connects to as many tFixedSizeMemoryPool as required, as shown in Fig.12. tFixedSizeMemoryPool is a componentized kernel object of TOPPER-S/ASP3 for allocating and release memory areas of a requested size. tFixedSizeMemoryPool components of various sizes are

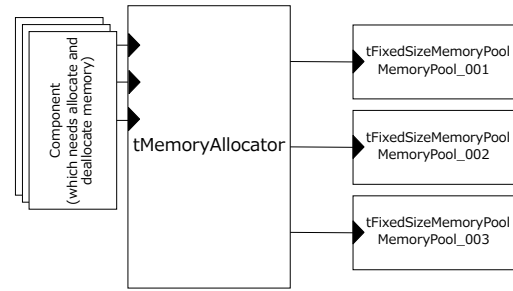


Fig. 12 Component diagram of tMemoryAllocator

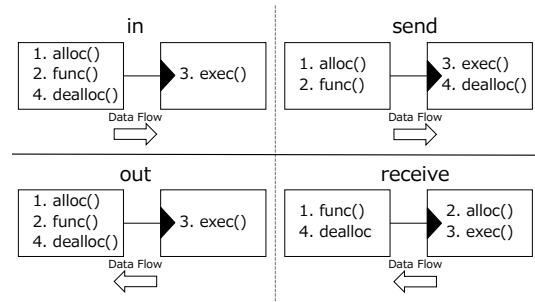


Fig. 13 Differences between in/out and send/receive

prepared, and an appropriate memory area can be allocated according to the used data size. On the other hand, all components that need to allocate or deallocate memory, e.g., tTCPInput and tEthernetOutput, connect to the memory allocator component.

In addition, TINET+TECS utilizes the TECS *send/receive* specifier to minimize the memory copy frequency, which is a functionality supported by TINET.

Send/receive specifiers: TECS supports *send/receive* interface specifiers [26]. TINET+TECS uses *send* and *receive* specifiers instead of *in* and *out* to reduce the number of copies:

- *in* is a specifier for input arguments. A callee side uses the memory of arguments with *in* when executing the callee function. When the processing returns to the caller side, the caller can reuse and deallocate the memory.
- *send* is another specifier for transferring data to a callee from a caller such as *in*. The difference between *in* and *send* is whether the data memory is deallocated in the caller or callee, as shown in Fig.13. In the case of the *in* specifier, both allocating and deallocating of the data memory are performed in the caller. By contrast, in the case of *send*, the caller allocates the data memory and the callee deallocates it.
- *out* is a specifier for output arguments through which a callee writes data in the memory allocated by a caller while the caller receives the data.
- *receive* is another specifier for a caller receiving data from a callee such as *out*. The difference between *out* and *receive* lies in whether the data memory is allocated in the caller or callee, as shown in Fig.13. In the case of *out*, the callee writes data in the memory allocated by a caller, whereas in the *receive* case, the callee allocates the data memory. Deallocating of the memory is performed in the caller in both cases.

As shown in Fig.14, sending and receiving arguments such as

```

1 signature sNicDriver {
2   void start(
3     [send(sNetworkAlloc),size_is(size)]
4     int8_t *outputp, ..., ..);
5   void read(
6     [receive(sNetworkAlloc),size_is(*size)]
7     int8_t **inputp, ..., ..);
8   /* Omit: other functions */
9 };

```

Fig. 14 Signature description of the nic driver (An example of send/receive)

outputp and *inputp* are defined using, respectively, the *send/receive* specifier in the signature description. Developers hardly make mistakes of memory operation because these specifiers completely pass an ownership of memory. Common object request broker architecture (CORBA) does not consider memory sharing; CORBA has no functionalities such as *send/receive*.

3.2 TLSF+TECS

3.2.1 TLSF

TLSF (Two-Level Segregate Fit) memory allocator [27] [28] is a dynamic memory allocator suitable for the real-time system proposed by M. Masmano et al. TLSF memory allocator has the following features.

Real-time property

The worst execution time required for allocating and deallocating memory does not depend on the data size. TLSF always works with $O(1)$, and it is possible to estimate the response time.

Fast speed

In addition to being able to always estimate the worst execution time, TLSF is executed at high speed.

Efficient memory consumption

Memory efficiency is improved by suppressing memory fragmentation. Various tests have obtained an average fragmentation of less than 15% and a maximum fragmentation of less than 25%.

3.2.2 TLSF Algorithms

TLSF algorithm classifies memory blocks into two stages and searches for a memory block that is optimal for the requested memory size. The overview of TLSF algorithm is shown in Fig.15. Consider a case where a request, *malloc*(100), is called to allocate a memory. In the first step, it is classified by the most significant bit of the requested memory size. In this case, since 100 is represented by binary number as 1100100, it is in the range from 64 to 128 from the most significant bit. In the second step, it is further classified. In this case, 64 to 128 are divided into 4, and 100 is in the block of 96 to 111. Free block ^{*2} in this range is used.

A simple fixed-size memory block allocator results in waste of up to 50%, but TLSF classifies it finely in two steps, so it is a memory efficient algorithm. In addition, TLSF searches at the same speed and at high speed, $O(1)$.

3.2.3 Component Design of TLSF+TECS

This section describes the component design of TLSF memory allocator. In this research, we are using TECS to componentize

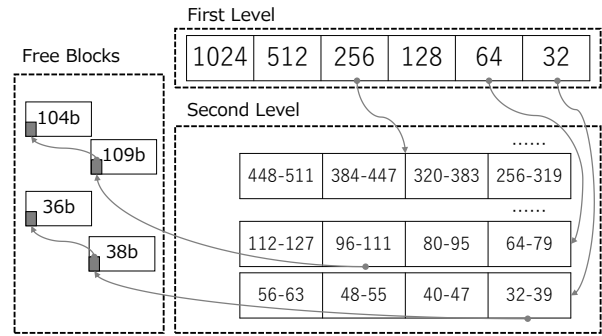


Fig. 15 TLSF Algorithm

```

1 signature sMalloc {
2   int initializeMemoryPool(void);
3   void *calloc( [in]size_t nelem,
4                 [in]size_t elem_size );
5   void *malloc( [in]size_t size );
6   void *realloc( [in]const void *ptr,
7                  [in]size_t new_size );
8   void free( [in]const void *ptr );
9 };

```

Fig. 16 Signature description of memory management

```

1 celltype tTLSFMalloc {
2   [inline]
3   entry sMalloc eMalloc;
4   attr {
5     /* memory pool size in bytes */
6     size_t memoryPoolSize;
7   };
8   var {
9     [size_is( memoryPoolSize / 8 )]
10    uint64_t *pool;
11  };
12 };

```

Fig. 17 Celltype description of TLSF memory allocator component

TLSF. The version of TLSF used is 2.4.6^{*3}.

Fig.16 is a signature description for memory management used by the allocator. It defines the memory pool initialization function *initializeMemoryPool*, memory allocation function *calloc*, *malloc*, *realloc*, and memory release function *free* as signatures.

The celltype description of the TLSF memory allocator component is shown in Fig.17. An entry port, *eMalloc*, is connected to all components that perform memory management such as *malloc* and *free*. Here, *[inline]* is a specifier for Implementation as inline functions. A memory pool size is defined as an attribute, and a pointer to a memory pool is defined as a variable. Each component holds its own heap area, so even when calling functions for memory management at the same time in different threads, it is possible to operate without memory contention.

As shown in Fig.18, since TLSF before componentization shares the heap area with multiple threads, if memory is allocated or released simultaneously from multiple threads, memory competition may occur in some cases. In the research, TLSF is componentized using TECS as shown in Fig.19. It is possible to operate in thread safe without exclusive control, because each component independently holds a heap area and manages memory within it.

Fig.20 shows the build description of the TLSF memory al-

^{*2} Free block is an available memory block.

^{*3} <http://www.gii.upv.es/tlsf/main/repo>

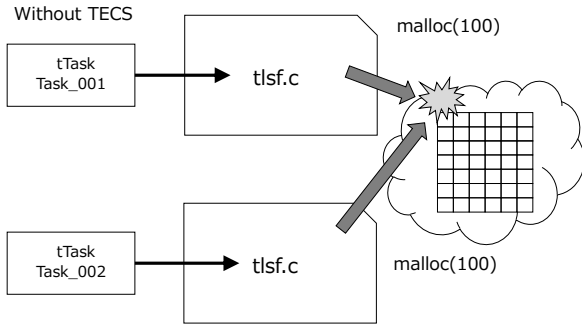


Fig. 18 TLSF before componentization

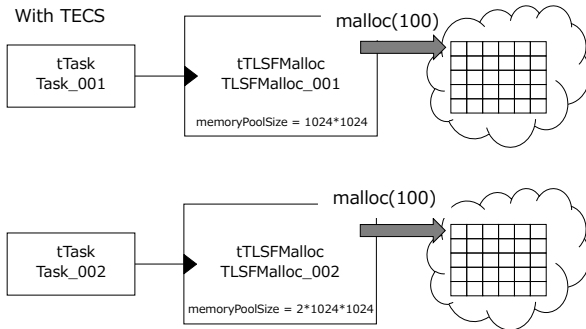


Fig. 19 TLSF after componentization

```

1 cell tTask Task_001 {
2   cMalloc = TLSFMalloc_001.eMalloc;
3 };
4 cell tTLSFMalloc TLSFMalloc_001 {
5   memoryPoolSize = 1024*1024; /* 1MB */
6 };
7 cell tTask Task_002 {
8   cMalloc = TLSFMalloc_002.eMalloc;
9 };
10 cell tTLSFMalloc TLSFMalloc_002 {
11   memoryPoolSize = 2*1024*1024; /* 2MB */
12 };

```

Fig. 20 Build description of TLSF memory allocator component

```

1 void*
2 mrb_TECS_allocf(mrb_state *mrb, void *p,
3               size_t size, void *ud)
4 {
5   CELLCB *p_cellcb = (CELLCB *)ud;
6   if (size == 0) {
7     //tlsf_free(p);
8     cMalloc_free(p);
9     return NULL;
10  }
11  else if (p) {
12    //return tlsf_realloc(p, size);
13    return cMalloc_realloc(p, size);
14  }
15  else {
16    //return tlsf_malloc(size);
17    return cMalloc_malloc(size);
18  }
19 }

```

Fig. 21 Example of TLSF memory allocator component

locator component shown in Fig.19^{*4}. Two sets of task components and TLSF components are combined. Each memory pool size can be configured as a variable (Lines 5 and 11 in Fig.20).

^{*4} Other call/entry ports, attributes, and valuables are actually described, but it is omitted here for the simplicity.

Fig.21 is the part of the code actually calling the function of the TLSF memory allocator component. The use part shows a function that the mruby VM allocates memory in the mruby on TECS framework [9] [15] which is introduced in Section 2.3. Lines 8 calls the *free* function of the TLSF memory allocator component. *cMalloc_* represents the name of the calle port (Lines 2 in Fig.20). Likewise, Lines 13 and 17 call the function for memory allocation. The heap area of *TLSFMalloc_001* component is used if the code of 21 is executed in *Task_001*, and if that is executed in *Task_002*, the heap area of *TLSFMalloc_002* component is used, respectively. In this way, in the component-based development using TECS, it is possible to operate with the same code without modifying the C code, although the cells are different.

4. Evaluation

5. Related Work

6. Conclusion

Acknowledgments

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